

CSIR - Central Electronics Engineering Research Institute (CSIR-CEERI), Pilani**Procurement Plan for the Year 2026-27 onwards**

Date 23.02.2026

CONSUMABLE

S. No.	Name of Item(s)
1	Sputtering Targets
2	silicone gel
3	Chemicals (acetone, IPA, HCL, KOH, H2O2 etc)
4	Gold pallets, Ti, Ni, Pd, Ni etc
5	Photoresist, LOR, PG Remover, developer etc.
6	Office consumables (cartridges, haddisks, pendrives, etc.)
7	Device packages, headers, zigs etc.
8	SiC Wafer
9	Photoresists, etchants, plating soln etc
10	Antenna, switches etc
11	Battery
12	LiTaO3 wafers
13	Flame Detector Evalution Kit and other accessories
14	Multichannel detectors, array
15	Pyroelectric materials/Targets Chemicals, PCBs and accessories, IR windows, Epoxies, Packages, Silver/Gold Material etc
16	Packages
17	THz Windows, THz source, THz detectors, THz Lenses, Epoxy: Conducing, Nonconducting and potting compound and other accessories
18	Electronic components, PCBs and accessories, Electronics components: PCBs, ICs, resistors, capacitors, etc
19	High power QFN Packages
20	QFN MMIC PA packages
21	Soldering kit

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22	Voltage sensors, current sensors, and temperature sensors. Microcontrollers, inductors, capacitors (high-voltage and high power electrolytic, ceramic, and film capacitors), resistors, SiC based switching devices, diodes, MOSFETs/IGBTs, transformers, integrated circuits (ICs), and connectors. Passive and active components, Connecting wire (high-voltage, high-current), Development boards, PCB fabrication, PCB blanks, wires of different specifications, and miscellaneous assembly items required for safety control. High-voltage power modulator units, DC–DC converter modules, AC-DC PFC converter subsystems, DC-AC modular converter architecture, high-frequency inverter modules, and laboratory prototype hardware subsystems. Mechanical structures and mounting hardware supporting the overall system. Solder (lead-free and high-temperature variants), flux, solder paste, and etching chemicals. Heat sink, thermal paste, heat-sink compounds, insulating pads (silicone or mica), and adhesive tapes. High-voltage insulating tapes. High-voltage fuses, probe tips, calibration standards, and disposable grounding straps. Mechanical structure, Finolex wire with various specifications, Litz wire, Thimbles, FR4 transformer former sheet: Epoxy sheet, Transformer and inductor cores, Teflon rods; shielded cables or wires with different cores, including 3-core cables; Teflon sleeves (simple and Teflon) in sizes 1 mm, 2.5 mm, and 4 mm; PCB drill bits of various specifications; high-voltage paint; HV gloves, electrical tape; HV tape; soldering iron bits; and low-dropout regulators (LDOs). Transformer and inductor Bobbins, batteries with various ratings, Connectors PLC and its related accessories and other miscellaneous electronics and electrical components etc.
23	GaN, Wafers
24	Gallium oxide, Wafers
25	SiC epitaxial wafer
26	Miscellaneous items

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27	RAM 16GB DDR4, 2666MHz, No. of Pins-288 RAM 8GB DDR3, 1600MHz, No. of Pins-240 RAM 8GB DDR3 SODIMM W4, 1600MHz No. of Pins-204, Compatible with All in One PC RAM 4GB DDR3, 1600MHz, No. of Pins-240 RAM 16GB DDR4, 2133MHz Pen Drive 64GB HP Black Toner cartridge- CC388A (88A) HP Black Toner cartridge- Q2612A (12A) HP Black Toner cartridge- W1370A (137A) Internal Solid State Drive (SSD) 1024GB, 2.5inch
28	MFC, GATE VALAVES
29	Target metal Al, Cr, Pt, Pd, Ti, Ni
30	silicon wafers
31	Etchants (Poly, Aluminum, etc.)
32	Glass wafers
33	Electronic Components
34	PG Remover
35	Photoresist, Developer,LOR
36	Si Wafer
37	Package, Window
38	Diamond Substrate
39	Gases(CH ₄ , H ₂)
40	Sputtering Target (MgO, ZnO/ MgZnO)
41	DND Seed, Chemicals/Powder, Epoxy
42	Cartridge, UPS Battery, Hard Drive
43	AlGaN epitaxial grown wafers
44	Diamond substrates
45	TO Packages
46	Gold pellets
47	Photoresist
48	Photoresist developer
49	Lift-off Resist
50	Gloves

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51	Lint-free tissue paper
52	All types of motors stepper, BLDC, DC, Indusction etc
53	Motor drivers and power systems
54	Embedded Systems and borads, SBC, Raspberry pi, Jectson NVIDIA, ESP, Arduino and dsPIC and STM development boards etc
55	Sensor and actuator materials and their accssories
56	Electronic components and Sensors and modules vision, obstacles, voice, ultrasonic, laser, temperature, LiDAR, Webcam, wireless devices etc
57	Software updates and subscriptions
58	Probes - voltage, current and their accessories etc
59	Electrical wires, tapes, harnesses, connectors etc
60	Mechanical AL Sheets, Perspect Sheets, Screw, nut, bolts, Tube, types, wheels etc
61	Computer accessories - printer cartridges, tonners, headset, mouse, keyboard, wired / wireless, memory ssd and Sd etc
62	Stationary - files, covers, folders, pen, pencile, rubber, duster, feviquick, bond, all tapes, fevibond, registers, saop, etc
63	Chargers and batteries lead acid
64	Chargers and batteries Li-ion
65	Robotics and mechanical wheelchair mechanisms and platforms
66	Charger, Battery, accessories
67	Electronic Items and accessories - lcs, Resistor, Capacitors, MOSFEST and wiring etc.
68	IC design
69	Daughter card
70	PCB design, fabrication and assembly
71	Stationary item

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72	Testing of the developed design in different institutes/facilities
73	Electronic Components
74	Fault Injection Probe MT-676E(E-field)
75	Fault Injection Probe MT-676H(H-field)
76	MT-545 Probe
77	YKC-1000 pre-amplifier set
78	WM1019-0453H
79	WM1019-0460C
80	Misc.
81	Fabrication of Sensors
82	Metal Cane Packages
83	Ceramic Packages
84	Spare parts for equipment
85	Electronics Chips, ICs, and other components
86	Commercial sensors for seismography
87	Cartridge, antivirus and SMPS
88	Metal base and PCB fabrication
89	Quartz Material
90	Electrical Components/Items
91	Metals/Insulators/vacuum components
92	Cartridge, some stationary
93	Metals and insulators – SS rod/OFHC copper, Teflon, Perspex rod, wires, SS sheet, Perspex sheet, ceramics
94	Chemicals: organic solvent, chemicals, laboratory consumables, etc,
95	Electrical and optical components, etc,

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96	Metals, insulators, chemicals, optical components and computer accessories: SS rod/OFHC copper, Teflon, Perspex rod, wires, SS sheet, Perspex sheet, ceramics, organic solvent, chemicals, laboratory consumables, etc, and some electrical, gas and optical components, Neutral density filters, radiation sources, , glasswares, Computer Accessories, Development boards, Sensor, actuator, PCB fabrication, electronics components (resistor, capacitor, inductor, Transistor, Analog IC, Microcontroller, communication modules etc.) etc.
97	Brazing Alloys: Co/Au/Ag
98	Voltage sensors, current sensors, vibration sensors, Capacitors, Diodes, Transistors, Inductors
99	CDAC ARIES v3.0 (Qty:05), CDAC ARIES IoT v2.0 (Qty:05), CDAC ARIES v2.0 (Qty:05), CDAC ARIES MICRO v1.0 (Qty:05), CDAC ARIES ALPHA v1.0 (Qty:05), ARIES NOVA v1.0 (Qty:05), ARIES ECO v1.0 (Qty:05), VSDSQ-PRO SiFive FE310-G002 RV32IMAC core RISC-V SoC (Item (Qty.: 02), VSDSQ-Ultra: VEGA ET1031 Processor family with RV32IM RISC-V core (Qty: 01), VSDSQM CH32V003F4U6 chip with 32-bit RISC-V core (Qty:01), VSDSQM Mini Core ICE40UP5K-SG48ITR with FTDI FT232 Board (Qty: 01), NavIC GPS with antenna (Qty:05),NavIC GPS Tracker (L1+L5 band) (Qty:05), RP2040 MCU with a mini 1120 LUT (Qty:05), GP-02 Precision GPS/GNSS Module (Qty:05).

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100	Metal and non-metal wire, sheet, rod and tape such as Kovar, OFHC, Brazing alloy, Tungsten, Molybdenum, Nickel, SS, Aluminium, Tantalum, ceramic, Sputter target, etc.
101	Chemicals, metal and non-metal powders Viz. Ba and Ca compound, Aluminate, nitric acid, methanol, NaOH, K ₃ FeCN ₆ , metal Salt, organic and inorganic compound
102	Non-metal rod and sheed, (Graphite, Ceramic, glass, Teflon tape, etc)
103	Electrical and electronics items
104	UHV components and accessories such as X-Y-Z Manipulator, Valve, gauge with controller, Gasket, feed through, Flanges, fastener, glass and ceramic bids, Isolator, reducer, etc.
105	Electrical, electronics and labware items.
106	Vacuum line with pressure controller and control valve, Pneumatic valves, Gas pipe wall fitting with materials like VCR male and female connector, Tee connector, NRV check valve, VCR Gasket, male, female nut and gland connector, gas cylinder
107	Misc. Items like nut & bolts, gloves, petry disc, tissue paper, etc.
108	
109	IR windows and source
110	IR detectors
111	Minor electronic components
112	PCB fabrication
113	Pumps and accessories
114	Mechanical Assembly and fabrication
115	Miscellaneous mechanical components
116	IR LVF filter-based array
117	Lock-in amplifier boards
118	Electronic components, ICs and other computer accessories
119	Motor controller
120	Optical components

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121	VCSEL laser and drivers
122	Office Stationery (including for recruitment, office usage etc)
123	Mechanical & PCB Fabrication
124	Embedded development boards, processor chips, OLED, LCD, ECG electrodes, Sensors, Lithium Batteries, switches, steering wheel covers, conductive Fabrics, Conductive sheets, Multiple gauge wires, PCB soldering Stand, Soldering accessories, Multiple type USB cables, Speakers, Electronics writing pads, X-ray medical aprons, SD cards, Pen drives, 3D Printing prototypes, Educational Kits, RAM, Hard Disk
125	Field Data Collection
126	Photo-optic units consisting of IR Sources, Lenses, collimation units, probes, fibers, mounts, detectors, and other accessories.
127	Assorted Electronic components, sensors, I/O Units, RF modules, cables, connectors, convertors, extension cords, development boards, and Adaptors.
128	Raw materials and tools for mechanical fabrication work such as aluminium/MS frames, aluminium/copper sheets, assorted nuts, bolts, bearings, springs etc.; rubber/plastic hose; pneumatic/hydraulic valves and systems; and other accessories
129	Batteries, power supply modules, power backup system
130	Items for conducting Training program and workshop
131	Printer cartridges and toners
132	PCB fabrication and stencil work
133	Assorted pneumatic/hydraulic components for sorting
134	IR Lamps of assorted wattage
135	Electrical wires and cables

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136	Materials for reflective coating
137	NIR Lenses of different focal lengths
138	NIR optical filters
139	NIR photodiodes
140	Assorted electronic components
141	Assorted mechanical tools and components
142	NIR Range optical cables
143	Interface Cards and boards
144	Slit, Mirrors, Lens, Doublet, Cuvette holder, etc
145	PCB Fabrication
146	Registration fee for the staff attending seminars, conferences, etc.
147	PU connector
148	Motor with controller
149	Pulley
	Bearing
150	Caster Wheel
151	UHV pneumatic valve
152	SMPS
153	Fluke DMM fuse
154	Rail mount Contractor
155	Spray paint
156	Acrylic sheet
157	Teflon rod
158	Teflon sheet
159	SS Rod
160	Tissue paper
161	Single Axis robotics arm with motor and controller
162	PLC
163	HMI
164	Rail mount Relay
165	Connector
166	ADC card
167	Temperature card
168	RTD
169	Thermocouple
170	PU Pipe 6,8,10,12 mm
171	Thimble

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172	Molybdenum sheet
173	316 Stainless steel Rod
174	K-10 Tungsten Rod/ slab
175	Tungsten Wire
176	Tungsten Rhenium Wire
177	Thoriated tungsten wire
178	Tungsten-Re Heater
179	Molybdenum wire
180	Nickel Wire
181	Nichrome Wire
182	Ceramic isolator
183	Metallize ceramic
184	High-density graphite
185	Molybdenum sleeve
186	Tantalum sleeve
187	Molybdenum powder
188	Ruthenium powder
189	Alumina
190	Barium Carbonate
191	Calcium carbonate
192	Aluminium oxide
193	Nitric Acid
194	Methanol
195	Acetone
196	Potassium ferrocyanide
197	Sodium hydroxide
198	Thyristor
199	Vacuum gauge with controller
200	Flow sensor
201	Pressure Sensor
202	Vacuum Bel jar
203	Sputter Gun
204	RF source, RF components, waveguide, coaxial line, SS sheet, Rod, Teflon sheet and rod, PLC controller, microcontroller, semiconductor devices, display, embedded board, passive components, wires, ICs, PCBs (<i>multiple quantities</i>)
205	1kW CW Magnetron with Power supply

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206	Gas separator
207	Material like SS, teflon, quartz
208	WR 340 waveguide
209	Fabrication of 915MHz hydrogen applicator
210	Gaseous components like pneumatic valve, filter, pp tube, connectors
211	Electrical & electronics components for PLC-based controller
212	Temperature sensor with controller
213	Gas cylinder/refilling- CH4, CO2
214	Materials like SS, quartz, Teflon, copper
215	Wires, DC MCBs, Solder wire, cartridge, DC loads and other minor components
216	PCBs, MOSFET, Microcontroller, Current sensor, Magnetic cores, Breakout boards, Diodes, Connectors
217	SMD DC-DC converter, Gate driver, optimizer modules, CR2032 cells, LEDs, IP 65 boxes, displays, SMD resistors, carbon wire resistors, Electrolytic capacitors, DC fans, heat sinks, power inductors, other petty items
218	Thermocouple, SD cards, cables, passive probes, minor consumables
219	resistive loads, Heavy duty 48/72 V Lithium batteries
220	PCBs, PCB mount hall sensors, SD card readers, RTCs, breakout boards, IoT devices
221	Actuators, control modules, Modules for existing Matlab software for hardware
222	and software in loop validation, other petty items
223	pH, TDS, temperature, chlorophyll, turbidity sensors, voltage sensor, current sensor, etc.
224	Internet of Things (IoT) enabled- devices, ultrasonic transducers, batteries, power cables, linear ICs, semiconductor devices, passive components

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225	controllers, heat sinks, Actuators, GPS modules, IP68 boxes,
226	Electronic components for charge amplifier-based readout design (opamp, Jfet, capacitor, resistor, microcontroller, li-ion battery)
227	PCB fabrication (<i>multiple revisions and quantities</i>)
228	Thick-film paste/ reference sensor with readout unit
229	Thick-film paste (Ag, Pd/Ag, Au, Au/Pt, Pt, etc.), resistor paste, reference sensor with readout unit, Electronic components (Operational amplifiers, ICs, JFETs, Capacitors, Resistors, Microcontrollers, Li-ion batteries), PCB fabrication, Kim Wipes, Beakers, UPS batteries, cartridges, computer accessories Screen Preparation Materials, Solder pastes, solder wire, Epoxies, Sealants, Adhesives, High-resolution photoplots and masks, PZT powder/paste, PZT plate/disc/ring, Spares/accessories of existing equipment, wifi & Bluetooth modules, LCDs, small solar panel, adapters, cables, connectors etc.
230	Kim Wipes, Beakers, UPS batteries, Cartridge etc.
231	Photoresists, IR filters, Semiconductor grade etchants for metals/dielectric, Organic and inorganic chemicals
232	Pyroelectric materials/Targets Chemicals, Silicon, SOI and Glass Wafers, Silicon micromachining Chemicals, PCBs and accessories, IR windows
233	IR Windows, Epoxy: Conducting, Nonconducting and potting compound,
234	PCBs and accessories, Piezoelectric materials, Device packages, headers, Teflon and similar materials, Glassware, printer cartridges and Computer accessories.

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235	IR filters and small petty items as required for the project, Electronics components: PCBs, ICs, resistors, capacitors, and accessories
236	Pyroelectric substrates/targets, chemicals, glass substrates, metallic wires/pellets, electronic components, PCBs and accessories, Electronics components: PCBs, ICs, resistors, capacitors, and accessories, Piezoelectric materials, Device packages, headers, Teflon and similar materials, Glassware, printer cartridge and Computer accessories etc.,
237	THz Windows, THz source, THz detectors, IR filters, IR windows, Epoxy: Conducting, Nonconducting and potting compound
238	Photoresists, developer, Semiconductor grade etchants for metals/dielectric, Organic and inorganic chemicals. chemicals, Silicon, SOI and Glass Wafers, Silicon micromachining Chemicals, PCBs and accessories
239	LiTaO3 wafers, Photoresist, developer, chemicals
240	IR detector array, LVF, IR Windows
241	Epoxies
242	Metal beads, Sputtering Target
243	IR Source, Electronic Components, PCBs
244	High purity gases
245	ICs (DC buck convertor, amplifier, connectors, arduino, display, etc)
246	Consumable requirements for common R&D Lab facilities in Clean Room and Workshop (generic/ miscellaneous)
247	Gold (Au pellets/shots)
248	Ethanol
249	Flexible PCB
250	PCB for modules/ customised circuits
251	Microcontrollers

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252	Capacitor, Resistor, Inductor etc. (<i>multiple components & quantities</i>)
253	LiPo battery
254	Bluetooth module
255	IO-PET
256	Keyboard
257	Mouse
258	Printer cartridges
259	PET sheet
260	Al foil
261	PFOTS
262	Battery charging IC
263	Battery protection IC
264	Dual N-channel enhancement mode power MOSFET
265	LEDs
266	FDC
267	Crystal Oscillator
268	Flash IC
269	USB connectors (<i>1.1 type A etc.</i>)
270	Switch (push button)
271	DC power jack connector
272	AC/DC power adapter with cable
273	PEDOT: PSS
274	PVDF-HFP
275	EMIM TFSI
276	Outsourcing for customised requirements (Fabrication of GaN HEMTs)
277	Two Power Amplifiers with 15 to 20 GHz and two W-Band, 75 to 110 GHz
278	Optical sources, detectors, filters and windows, adulterants, oils
279	Electronic components, enclosures, chemicals, mechanical parts, electrodes and multi-layer PCB fabrications
280	Plants and seeds, chemicals and insecticides
281	Pipe and fittings
282	Electronic components, wires, PCB etc
283	PLC and accessories

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284	Dose pump and other accessories
285	Keypad 20x4, Microcontrollers ESP32, PTH LEDs, Servo DC motors, 555 timer, solder wires, resistors 1 KOhm, 4.7 K ohms, Adapters, Extension boards, jumper wires, PCB Boards, USB to serial Cables, BLE/WiFi boards, MCP6022, CD4050 ICs , Brad Boards, Zero PCBs, Folder, Notebook, Pens, LEDs, Wires, Sensors (Soil, temperature, humidity, acoustic etc) (<i>multiple quantities</i>)
286	PCB for Voltage and Current Sensing, Auxiliary Circuits, PFC Circuits
287	Miscellaneous Mechanical Components, Induction Coil, air and liquid pumps
288	Third party testing of Milk for Bacteria Count, NO3, NO2 content in water etc.
289	Litz Wires, Ferrite Cores, Lugs,
290	PCB for Resonant converters, Battery Charger circuits
291	Electronic Components MOSFETs, microcontrollers, isolated converters, opamps, drivers
292	IGBT drivers, temperature Sensors, touch interface, isolated converters, opamps, drivers (<i>multiple quantities</i>)
293	PCB for Pulse Generation Circuits, PFC and Sensor Boards
294	Touch Display, microcontrollers, power devices, isolated converters, opamps, drivers
295	Electronic consumables for lab & workshop
296	Ultrasonic Sensor/ Transducer Fabrication
297	Electronic Components, drivers, motors, Microcontrollers, OP-AMP, ESP32
298	Aluminium Mirror Sheets, MS Sheets, Nylon Sheet, Acrylic Sheet, MDF Boards.

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299	Aluminium fin, Industrial-grade Copper Pipe and MS Pipe
300	Wires, insulating material, connectors, Electronics Components, Digital temperature meter
301	Synthetic Oil/ Normal Oil/coolant
302	Vacuum Glass tube (~1m to 2m Length and ~15Cm Diameter)
303	Leaded Solder Paste SN63PB37- Type 4
304	IPA Liquid cleaning solution
305	SMT Double Splicing Tape-8mm
306	Nitrile Hand Gloves
307	Servo Stabilizer
308	Fire Cylinder Recalibration & Refilling
309	Housekeeping Items for sanitation, office etc.
310	Op-Amp, MOSFET, LNA
311	RF Transceivers
312	Voltage regulators, SMPS
313	Sensors: Environment, GPS, accelerometer
314	Microcontroller Units
315	Display devices, keypad
316	Cables & connectors
317	Optical Components (Source & detectors)
318	Calibration of Temperature Probes, Safety Analyser
319	Calibration of Power Analyser, Oscilloscopes
320	Calibration of Power Analyser, Oscilloscope
321	Electronic Components, PCBs, Mechanical components
322	IGBT drivers, Sensors, touch interface, electronic component
323	Validation of Consumable content in water etc.
324	PCBs and other Electronic Components
325	Electronics consumable.

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326	Electronic Components Mosfets, opamps , drivers, PCBs
327	Cartridges, some lab and office stationery
328	Gasline Components
329	Electrical and optical components etc. as required for projects
330	Development boards, Kits, programmers, Integrated circuits, Discrete semiconductor products, Resistors, Inductors, Capacitors, coils, chokes, Potentiometers, Variable Resistors, Crystals, Oscillators, Resonators, Optoelectronics, Memory Cards, Modules, Communication devices (wired and wireless), Displays (OLED, LCD, TFT etc.)
331	PCB development & fabrication, Mounting of components
332	Tapes, Adhesives, Materials, 3D printer filaments, Computer/Laptop spare parts, Magnetics-Transformer, Inductor Components, Pumps, Battery products, Power Supplies (board mount, internal module, SMPS etc.),
333	Fabrication of CMOS Data Converter IC, Semiconductor Devices
334	Photoresists (SU8, S1818 etc.), Semiconductor Grade etchant for metals and dielectric, organic, inorganic and other chemicals and gases.
335	Silicon, SOI and Glass Wafers, Silicon micromachining Chemicals.
336	Piezoelectric materials, epoxy conducting and non-conducting, Photoresist Developer and small petty items as required for project, Device packages, headers, Teflon and similar materials, Glassware, printer cartridge and Computer accessories.
337	Electronic components: ICS resistors capacitors and accessories.
338	PVDF

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339	MPTMS
340	ARDUINO development board
341	Copper Wire
342	Surgical Blades
343	Micropipette
344	Fabric Gloves
345	Copper Tape
346	Aluminium Tape
347	Plastic Pipettes
348	Hot Air Blower
349	EMG sensor Parts and ECG electrode
350	Neurosky mindwave kit
351	ATMEGA328P SMD IC for ARDUINO Nano/UNO
352	REES52 4Pcs NRF24L01+ Wireless Module with Voltage Regulating Breakout Adapter
353	Gold Target
354	Velcro straps
355	Resistor, Capacitor
356	ESP32 D4 SMD
357	Zero PCB
358	Digital Discovery Portable Logic Analyzer and Digital Pattern Generator
359	Raspberry pi
360	Robotic 3d printed hand
361	Digital Vernier Calliper
362	Teensy Development Board
363	UHF Reader Based on Pico W / ESP32
364	UHF Reader
365	PiCoder - Compact DIY Raspberry Pi Pico Learning Kit
366	ESP32 3.5 inch Touch RGB Display
367	SSD, USB and other peripheral devices for Computer
368	RAM 16/32 gb
369	Sputter targets, FeGa, Al, FeCo
370	Photoresist, Developer
371	Gold Metal
372	IR detectors, sources, gratings, filter, and other optical components

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373	TO headers
374	Miscellaneous Electronic components (micro-controllers, displays, thermal printer modules etc.)
375	PCB fabrication for various modules
376	LN wafers
377	Polyimide/ polymer sheets
378	Thermal conducting and electrical insulating chemicals/ resins/ particles
379	Device, Sensor Packages
380	Electronics Components
381	Silicon Substrate
382	Electrical and Electronic components (<i>as resistors, capacitors, ICs etc.</i>)
383	PCB boards
384	Evaluation boards
385	Nano-VNA
386	RF components cables and connectors
387	Aluminium Sheet, Teflon sheet and rod, Sample material (grains), 3D printing filament,
388	Temperature sensors, capacitive moisture meters, Heat sinks

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389	Electronic and electrical items (PLC CONTROLLER FBS 24IO Tr.PNP ETH + 6RTD, Temperature sensor module 6TC, RTD Sensor, GXU HMI Panel for PLC, 7.5"W TFT, SL + ETH, PLC TO PC Communication Cable, HMI TO PC Communication Cable, 2C/O Relay 24vdc with base, Power Supply for PLC, Panel Box 500*500*210mm, Emergency PB, Push Button, Indicator Light, Selector Switch, WIRING CHANNEL 45*60, MCB CHANNEL, Terminal strip for fork thimble (4 mm and 6 mm), TERMINAL Block 2.5mm, Pin type copper thimble, Fork thimble 4 mm, 6 mm, Fuse TERMINAL for 5A, 8A, 10A, 15A, Fuse 5A, 8A, 10A, 15A, Ethernet Module, 1 Port Rs232 + 1 Port, Contactor- single phase/20A, Contactor- 3 phase/30A, 4" 230 Volt panel mount axial fan, HARDWARE, Panel Sticker, thimble, spiral, MCBs, Network switches)
390	Thermocouple, thermocouple readout display, Motor, Gearbox, Motor control and power supply, Pully, Belt, valves,
391	Gas flow meter, steel angle valve, non-return valve, pressure gauge, high duty wheels, push connectors, PU gas pipes, pneumatic cylinders, electro-pneumatic valve, electromagnetic valve, diaphragm compressor, PPM Analyzer (for H2, CH4 & N2), H2 storage tank, H2 sensor, Gases (CH4, Bio CH4, NH3, H2), Carbon separator filter, SS gas line and fittings, small compressor, water pump
392	RF Power meter with USB cable

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393	Metal sheets, rods, profile channels of different dimensions (SS, Aluminium, etc.) of customized sizes, glassware for distillation and glass utensils, sample holders and accessories, tetter bags for gas samples, Non-metallic sheets & rods of different dimensions (PTFE, Nylon etc.), ceramic/quartz glass components, RF Choke, screws, nut-bolts, cutter blades, Electrical & electronics items such as transformer, magnetron heads, transistors, inductors, coaxial cable, power substrates, evaluation boards, capacitor, transitions, diode, switches, Fuses, wire, matched load etc., Frequency measurement boards, display devices, RF leakage detector, PLC controller, display devices, chemicals, SMPS & associated devices (customized), arduino and raspberry pi boards, RF components
394	Laminates, material for antenna fabrications, high-frequency absorbers, Standard gain horn antenna etc
395	Sputter targets, FeGA, Al, FeCo, BST
396	High-frequency RF probes, Helmholtz Coil
397	Mu metal, copper fleece, Lock-in-amp., Charge amp.
398	Photoresists, developers, lab chemicals, removers etc.
399	Computer accessories and printer cartridges (<i>multiple types based on compatibility</i>)
400	THz Windows, THz source, THz detectors, IR filters, IR windows, Epoxy: Conducting, Nonconducting and potting compound
401	Silicon, SOI and Glass Wafers, Silicon micromachining Chemicals, PCBs and accessories, Photoresists, developer, Semiconductor grade etchants for metals/dielectric, Organic and inorganic chemicals.
402	OFHC copper rod and sheet, Brass rod and sheet, micro-fabrication tools, high frequency cables, adapters, computer accessories, fabrication of components, SBC boards, gold and silver pellets, upgradation of software, brazing alloys required for development, and characterization

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403	Power Amplifier with 15 to 20 GHz and two W-Band, 75 to 110 GHz
404	ICs and development board (DC buck converter, amplifier, connectors, arduino, display, etc)
405	Photoresists, Si Wafer, etchants, plating solution etc.
406	PCBs, desiccators, etc
407	Vacuum pump, devices and other Miscellaneous Items
408	Shielding Box for CV and RF measurements
409	DC and RF probes, cable, adapters, calibration substrate etc
410	Detectors Electron multiplier
411	Electroplating Set-up
412	Mixer, bandpass filter and other FE components
413	Gold Electroplating Solution
414	RF packages
415	Impedance analyzer accessories
416	Al foil paper, Glove, Filter paper, SS material and accessories and other items like Printer cartridges
417	Wafers, Photoresists, Developers, Metal electrolytes and etchants, Local oscillator
418	Raw materials for parts fabrication, brazing alloy, cathode, ceramics, window ceramics. RF components for cold test in the W-band frequency range for limited RF performance testing.
419	Laminates, material for antenna fabrications, high frequency absorbers, Standard gain horn antenna etc.
420	Motor controllers (<i>varying requirements</i>)
421	Other PCB fabrication components & Accessories
422	Metal electrolytes and etchants, Local oscillator, Wafers, Photoresists, Developers

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423	Internet of Things (IoT) enabled- Devices, sensors also include all cell, battery, power cables, and other minor components needed for data collection and portable data loggers, Data handling software and tools and other minor components needed for data collection, Modules for existing COMSOL and Matlab software for hardware and software in loop validation, also semiconductor devices, cables, controllers, passive devices, Actuators, control modules, communication & web publishing modules.
424	EEG Device Consumables used for Data Collection, Sensor Connectors, Embedded Platforms, other required Software Modules and hardware components/accessories.
425	Electronic boards and consumables, consumables for computers and software modules.
426	Components and Connectors for vision sensors with drone, connectors for embedded platforms, memory card for on-board storage, cables, other required Software Modules and hardware components/accessories.
427	AMC for Five DGX Servers, NetAPP SSD for Servers, AMC for UPS, Storage expansion system (Expansion kit, HDDs, GPUs), Spare Parts of DGX Servers, Monitoring and Cluster Management software (For Automated Scheduling and Analytics of Users), other required Software Modules and hardware components/accessories.
428	NVIDIA Compute Modules (SOM, Carrier Boards)
429	Repair parts (motor, ECS, Frame parts, propellers)
430	Battery: 6S 10000mAH

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431	Allen-key driver and other lab maintenance kits
432	1D Lidar
433	AirLink LTE Telemetry, LTE Link SE
434	RTK Modules, RTK Base
435	Computer Accessories, Printer Cartridge
436	Raw materials for parts fabrication, brazing alloy, cathode, ceramics, window ceramics. RF components for cold test in the W-band frequency range for limited RF performance testing, GPU cards for parallel processing
437	Methane gas
438	Sensors
439	Winding of copper coil
440	Transport charges
441	Aluminium target
442	Refilling of nitrogen gas
443	Alloy, gas line components
444	Characterization solutions
445	Colorimeter, empty cell
446	Base fitting arrangements
447	Fabrication Al jacket
448	Battery bank
449	Service charges of 160 kva 80 kva UPS
450	Power supply upgrade and components
451	Hydrogen Purifier (Spare of MOCVD)
452	Sodium 3 etc
453	Spare parts of VSM system
454	Transportation of chemical benches
455	Batteries (Multiple Types, including UPS)
456	Liquid Nitrogen
457	Liquid nitrogen tank filling
458	Transport service one trip
459	Renewable of adobe creative sw, figma, canva and other utility softwares
460	Lab Chemicals
461	Nitrogen gas (Refiling)
462	ABS Material battery

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463	Nobel Metals (Pt, Au, Si, Ti, Ag, Pd, W)
464	RF Front End Design Service
465	Al sheet, pump etc.
466	12V battery
467	GS Dielectric etc
468	4594.63-H72 PS2X4C2-AU S1.5(sensors)
469	Filters
470	Citric acid monohydrate
471	MS Sq pipe, angle etc
472	Repairing of mother boards,
473	PLA Black etc
474	Infrared emitter HIS 2000 RO etc
475	Part number 588237, S86744
476	CF Card
477	9v battery etc
478	Sputtering Target Gold 3" and 4"
479	Sputtering Target Platinum 3" and 4"
480	Cables 5 Core 4sqmm, 6sqmm,10sqmm
481	Trade test material for mechanical, Civil, Electrical and other such requirements
482	Chemicals (as required for Central Facility for Semiconductor, Vacuum Electronics and PCB)
483	Chemical waste disposal
484	Electronics components ICs, Board
485	Laser Dicing Consumables
486	Glass ware and cleanroom Aprons etc.
487	Internet lease line
488	AMC software
489	LAN cable, IO Port, tools, UPS batteries
490	Wire bonding tools and wires
491	Adobe creative cloud renewal
492	Plagiarism detection software renewal
493	Grammarly Software
494	ARVR Animation making SW and Tools
495	Customised cards, logos, placards miscellaneous
496	DIY Kits (Ardublock, Lego and other boards)

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497	Circuit Making Ink Pen
498	Science Educational Kits (Science Experiments, Customised IoT, Drone Educational Kit etc.)
499	Design Tools (Figma, Canva, Adobe)
500	Brain signal motifs
501	Screen Recorder
502	AV Accessories (Speakers, Mic, Camera, Audio Video & Display Accessories etc - set)
503	SMPS (varying performance)
504	LCD Panels for PCB
505	SSDs/ HardDisks/ Cables/ Batteries
506	Motors
507	Boards & sensor modules for experiments
508	RAM Sticks
509	PCB (consumables: Resistors, Capacitors, LEDs, Solder Paste etc.)
510	Plex Sheet
511	Consumable for 3D printer
512	Misc. items (like Batteries, Multimeters, USB drives, Google/Microsoft Storage space, USB adapters, File organizers, Computer Multimedia items like webcams, etc)
513	Stack AR Model Service, Animation Service
514	LED Light lamps/ panels
515	Lego or stacking elements for school projects
516	NMR grade Chemicals, solvents
517	Solder paste, nozzles, feeders etc.
518	Optical Filter
519	Optical Source and detector (MIR, NIR, Visible)
520	Automation boards
521	ICs, Microcontroller, Display boards
522	Wire bonding tools and wire spools
523	Design fabrication and evaluation of customized ASICs
524	Spare parts of sputtering machine

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525	Spare part of Vacuum Packaging Tools and Package
526	Spare MFC, Gauges, Controller etc.
527	SS Tubes, Valves, Connectors
528	PP Tubes, Flexible connectors, Cylinder Valves
529	PLC controllers, PCB connectors
530	PCB fabrication, glue, SMD components etc.
531	IC Packages, Cap etc.
532	Fabrication of MEMS Based Devices and other Semiconductor devices as per the requirements (<i>Multiple Devices and units</i>)
533	LVF 5.5um-11um, 128L TMI SP0.5 Chip, Thermal IR emitter, IR Emitter Bar EBS.5.100.0
534	128 pixel pyroelectric line arrays.
535	Mid-Infrared pulsable emitter.
536	Optical Window (ZnS)
537	Fabrication of Gyroscope
538	LVF, Sensor Array, LiTaO3 and PZT wafers, Chips, Die
539	MOSFETs, Diodes, IGBTs, Solid State Relay, Thyristors, SCRs, TRIACs
540	Gate Driver ICS, Voltage and Current Sensors, OPAMPS, Micro-controller, controller ICs.
541	Evaluation boards, PCBs, micro-controller boards, Communication boards, IoT Boards, HMI Display, TFT/LCD Display, Keypad
542	Wires, Litz wires, Resistances, SMD capacitors, Electrolytic capacitors, Inductor cores, power inductors, Ferrite cores, ferrite beads, mechanical relay

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543	RF Passive Components : Waveguide to Coax Adapter (Right Angle), Waveguide to Coax Adapter (Straight), Tapered Transition, 90-Degree E-plane Bend, Directional Coupler, Waveguide Straight Section, High Power Termination, 90° (RH) Twist, 45° (RH) Twist, Dial Type Attenuator, Direct Reading Attenuator, Waveguide to Coax Adapter (Right Angle), Waveguide to Coax Adapter (Straight), Tapered Transition, 90-Degree E-plane Bend, Directional Coupler, Waveguide Straight Section, High Power Termination, 90° (RH) Twist, 45° (RH) Twist, Dial Type Attenuator, Direct Reading Attenuator, Termination Load, RF Co-Axial Cable, 6 inches, RF Co-Axial Cable, 40 inches, RF Co-Axial Cable, 60 inches, 1mm (Female) End Launch Connector, 1mm (Female) Vertical Launch Connector, 0.8 mm (Female) Vertical Launch Connector, 1mm (Female) to 1mm (Female) RF Adapter, 1mm (Female) to 1mm (Male) RF Adapter, 1mm (Male) RF Matched Termination, Power Amplifier, VCO, Mixer, Frequency Multiplier. Termination, 1mm (M) to 1mm (M) Flexible RF Co-Axial Cable, 60 inches, Power Amplifier (solid state), VCO (solid state), Mixer (solid state), Frequency Multiplier (solid state).
544	Internet of Things (IoT) enabled- devices, ultrasonic transducers, batteries, power cables, linear ICs, semiconductor devices, passive components
545	IR emitters
546	Conducting and Non conducting epoxies
547	Copper tubes and other items for gas cell fabrication
548	Miscellaneous electronic items (resistor, capacitor, soldering wires, blank PCB, etc.)
549	PHOTOESIST
550	Gas Cylinders
551	PET/ Polyimide Sheets

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552	3D Printing Consumables
553	Gas connectors, fittings, regulators, headers and Computer accessories and parts, etc.
554	Fabrication of Prototypes, scanning structures, PCBS, conference registration fees, etc.
555	VCSEL lasers
556	THz optical components
557	Electronics, mechanical components and accessories
558	Maintenance of office equipment, miscellaneous and unforeseen, etc.
559	Electronic components and ICs and other computer accessories
560	Mechanical & PCB Fabrication
561	Raw materials for parts fabrication, brazing alloy, cathode, ceramics, window ceramics. Upgradation of existing PC to high end workstation with GPU card for parallel processing.
562	Epoxies
563	Pyroelectric materials/Targets Chemicals, PCBs and accessories, IR windows, Epoxies, Packages, Silver/Gold Material,
564	Pyroelectric substrates/Targets Chemicals, PCBs and accessories, IR windows, Epoxies, Packages, Silver/Gold Material
565	Pyroelectric substrates/targets, chemicals, glass substrates, metallic wires/pellets, and accessories, Piezoelectric materials, Device packages, headers, Teflon and similar materials, Glassware, printer cartridge and Computer accessories etc.,
566	Electronic components, PCBs and accessories, Electronics components: PCBs, ICs, resistors, capacitors,

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567	Piezoelectric materials, epoxy conducting and non-conducting, Photoresist Developer and small petty items as required for the project, Device packages, headers, Teflon and similar materials, Glassware, printer cartridge and Computer accessories.
568	Gas separator/PSA
569	Cold trap bath/Condenser
570	PLC components
571	1kW CW Microwave with power supply and cooling unit
572	Waveguides, horn antenna, stub tuner
573	Material like teflon, SS 304m Quartz Thermocouple
574	RF source, RF components, waveguide, coaxial line, SS sheet, Rod, Teflon sheet and rod, PLC controller, microcontroller, semiconductor devices, display, embedded board, passive components, wires, ICs, PCBs
575	Workshop components: Metal Rod (Brass, Stainless Steel, Die Steel, Mild Steel, Aluminium etc.), Metal Sheet (Brass, Stainless Steel, Die steel, Mild Steel, Aluminium etc.), Cutting Tools (EDM Wire & filters, HSS Tool Bit, HSS Drill, Bit, HSS Centre Drill, Milling Cutters, Carbide Bit, Bi-metal,
576	Band Saw Blade, Grinding Wheels, ER Cylindrical Collets & Chuck with M Nuts etc.),
577	Hand Tools (Cutting Files Rough & Fine, Hack Saw Blade, Emery Paper, Scribers, Centre Punch, Rivets & Rivet Gun, screw, nut, washer etc.)

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578	Other Consumables (Lubricant Oils, Soluble Oil, Hydraulic Oil, Kerosene Oil, EDM Filter, EDM Resin, EDM Diamond, Guide 0.16 & 0.26 Upper & Lower, EDM Energizing Plate, EDM Nozzle Upper & Lower, Bulb, Wheel for Trolley, Printing of Job Cards, Antivirus, Spare Parts of machine, maintenance of machine & other consumables required in workshop etc.)
579	Comprehensive maintenance of Central Workshop, Machine (Such as Turning Machine, Milling Machine, EDM, Wire Cut Machine etc.)
580	Cathode pellet
581	Thyristor/ SCR Metal (viz. Tungsten, Moly, Tantalum, SS, brass, Kovar, etc.) rod and sheet
582	Teflon rod and sheet, and Acrylic sheet
583	Chemicals (viz. Ba, Ca, Al ₂ O ₃ , HNO ₃ , Methanol, NaOH, Ag salt)
584	UHV Components
585	Nut, Bolt, Bearing, Shaft, Pulley, Belt, and Motor with Controller
586	Electronic and Electrical Items
587	Lab Consumables (e.g., Beaker, Gloves, Tissue Paper, Petri Dish, etc.)
588	Non-metal rod and sheet (Graphite, Ceramic, glass, Teflon Tape, etc)
589	GaN Epitaxy
590	Photoresist, developer, organic, inorganic chemicals
591	Metals for e beam evaporation (Ti, Al, Ni, Au, Pt)
592	Gallium oxide wafers
593	Mask fabrication plates
594	Conductive epoxy
595	Wafer box, Petry dish, Beaker, tweezer, sample box, face mask, gloves, glass plates, Q-tip, filter paper, Al foil, glassware, Al foil, vacuum desiccator, Chip holder box etc
596	SiC wafers and epitaxy

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597	Si substrates
598	Packaging material and organic chemicals for SiC processing
599	Semiconductor switching devices (IGBT/MOSFETs/GaN)
600	Gate drivers for IGBT/MOSFETs/GaN devices
601	User interface prototypes (touch-screens, buttons, LEDs)
602	Zip ties, cable ties, Velcro straps
603	Voltage and current transducers and its related circuitry
604	Passive components such as resistors, capacitors, and inductors
605	Fuses and circuit breakers
606	Solid state relays and contactors
607	PCB fabrication and hardware assembly
608	Heat sinks and thermal interface material
609	Li-ion batteries
610	Soldering wires
611	Integrated circuits (ICs) and boards
612	MCBs and relays
613	Magnetic components and cores
614	Opto-isolators
615	High-frequency ferrite-core transformers
616	Existing software license updates
617	FPGA, embedded boards
618	SMPS boards
619	Sensing components and circuits
620	Converters, stack and related circuits
621	Microcontroller and embedded boards
622	Communication interface circuits
623	PCBs board connectors
624	Soldering, Desoldering, Rework Components
625	Resistor, Capacitor, Inductor, Crystal
626	Embedded microcontroller and development board
627	Integrated Circuits (ICs)

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628	Voltage, Current, Thermal, vibration sensors
629	Thermal paste
630	Boxes, Enclosures
631	Heat sink
632	High power chip dicing and packaging
634	Gallium oxide epitaxy
635	MFC, pneumatic valve for dielectric
636	Sputtered Metal Target (Ti, Al, Cr, Ni)
637	Sputtered Metal Target (Pt)
638	Hardware enclosures and module fabrications
639	Lead acid batteries
640	Varistors / surge protection devices
641	Gate drivers modules for IGBT/MOSFETs/GaN devices
642	NTC thermistors / inrush current limiters
643	Heat sink and heat sink compounds
644	PCBs mounting connectors
645	PCBs fabrications and hardware assembly
646	Connecting wires with different size and diameters
647	Hardware fabrications
648	Integrated circuits (ICs) and electronics boards
649	Current and voltage sensors (e.g., Hall-effect)
650	Bridge diodes and normal diodes
651	Embedded computing module
652	Circuit Protection
653	Battery products
654	Connectors, Fans, and Thermal Management
655	Communication modules (WiFi, LoRA, ZigBee, GSM etc.)
656	Adhesive tapes
657	Insulation materials / creepage barriers
658	Enclosure materials (acrylic, aluminum sheets)
659	Active components like power semiconductor devices

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660	Insulating pads
661	High power packaging material, eutectic, ribbons etc., characterization tips
662	Device packages and connector, Printer cartridge, UPS Battery, pen drives, HDD
663	ICP-RIE Penning gauge and MFC
664	Sputtered Metal Target (Au)
665	High-voltage insulating tape
666	High-voltage and high-current fuses
667	Soldering, de-soldering and rework components
668	Test headers and pin sockets
669	Digital isolators
670	Hardware boxes
671	Enclosures
672	Cable assemblies, wires, cables with multiple strands
673	Integrated Circuits (ICs) and embedded board platforms
674	High-frequency transformer
675	Probe tips
676	High-voltage connectors and cables
677	Aluminium sheets, epoxy sheets, Teflon sheets
678	Push buttons, nut bolt, manual switches, metal bolts
679	Heat sink materials
680	High-voltage shielded cables
681	Low power DC-DC converter modules
682	Dielectric / isolation materials
683	Copper foil
684	Thermal cooling fans with related thermal circuits
685	Magnetics core bobbin
686	Breakout boards
687	Safety Materials Items
688	Lift Off Resist (LOR)
689	Headers and Packages
690	Packaging materials

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Please note:

- The procurement plan is not an intimation of procurement by CSIR-CEERI.
- This procurement plan does not impose any obligation on the Director, CSIR-CEERI, for the necessary procurement of these items.
- The procurement is subject to the availability of funds and R&D priority during the current financial year or in the coming years.
- The procurement plan is listed as of **23 February 2026** and shall be updated upon the commencement of new projects, programmes, research directions, or other emergent requirements, subject to the availability of funds in the respective financial years or thereafter.”